

Package

TO220F-3L

Description

The FMX-12SL is a fast recovery diode of 200 V / 10 A. The maximum $t_{\rm rr}$ of 30 ns is realized by optimizing a life-time control.

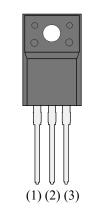
Features

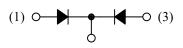
\bullet V _{RM}	200 V
• I _{F(AV}	₎ 10 A
• V _F	1.25 V
• t _{rr1}	30 ns

- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

Applications

- Secondary Side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck and Buck-boost Converter)





- (2) (1) Anode
 - (2) Cathode
 - (3) Anode

Not to scale

FMX-12SL

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage ⁽¹⁾	V_{RSM}		200	V
Repetitive Peak Reverse Voltage ⁽¹⁾	V_{RM}		200	V
Average Forward Current	$I_{F(AV)}$	See Figure 1 and Figure 2	10	A
Surge Forward Current ⁽¹⁾	I_{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	65	A
I ² t Limiting Value ⁽¹⁾	I^2t	$1 \text{ ms} \le t \le 10 \text{ ms}$	21	A^2s
Junction Temperature	T_{J}		-40 to 150	°C
Storage Temperature	T_{STG}		-40 to 150	°C

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Eastword Voltage Duon(1)	V_{F}	$T_J = 25 ^{\circ}\text{C}, I_F = 5 \text{A}$	_	_	1.25	V
Forward Voltage Drop ⁽¹⁾		$T_J = 100 ^{\circ}\text{C}, I_F = 5 \text{A}$		0.85	_	V
Reverse Leakage Current(1)	I_R	$V_R = V_{RM}$		_	50	μΑ
Reverse Leakage Current under High Temperature ⁽¹⁾	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}\text{C}$	_	_	10	mA
	t _{rr1}	$I_F = I_{RP} = 100 \text{ mA},$ 90% recovery point, $T_J = 25 ^{\circ}\text{C}$	_	_	30	ns
Reverse Recovery Time ⁽¹⁾	t _{rr2}	$I_F = 100 \text{ mA},$ $I_{RP} = 200 \text{ mA},$ $75\% \text{ recovery point},$ $T_J = 25 \text{ °C}$	_	_	25	ns
Thermal Resistance ⁽²⁾	R _{th(J-C)}			_	4.0	°C/W

Mechanical Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Heatsink Mounting Screw Torque		0.490		0.686	N∙m
Package Weight			1.8		g

 $^{^{(1)}}$ Specifies a value per chip; the FMX-12SL consists of two chips. $^{(2)}$ $R_{th \, (J\text{-}C)}$ is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Derating Curves

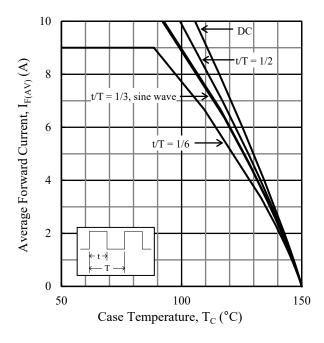


Figure 1. $I_{F(AV)}$ vs. T_C ($T_J = 150$ °C, $V_R = 0$ V)

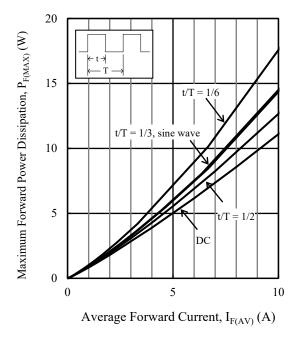


Figure 3. $P_{F(MAX)}$ vs. $I_{F(AV)}$ ($T_J = 150$ °C)

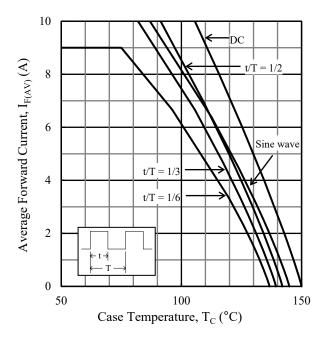


Figure 2. $I_{F(AV)}$ vs. T_C ($T_J = 150$ °C, $V_R = 200$ V)

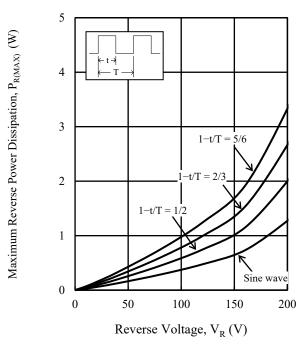
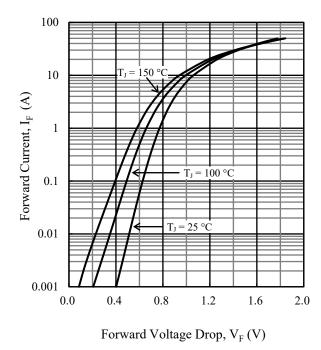


Figure 4. $P_{R(MAX)}$ vs. V_R ($T_J = 150$ °C)

Characteristic Curves



1.E-02

1.E-03

1.E-04

1.E-04

1.E-05

20

1.E-07

0 50 100 150 200

Reverse Voltage, V_R (V)

Figure 5. Typical Characteristics: I_F vs. V_F

Figure 6. Typical Characteristics: I_R vs. V_R

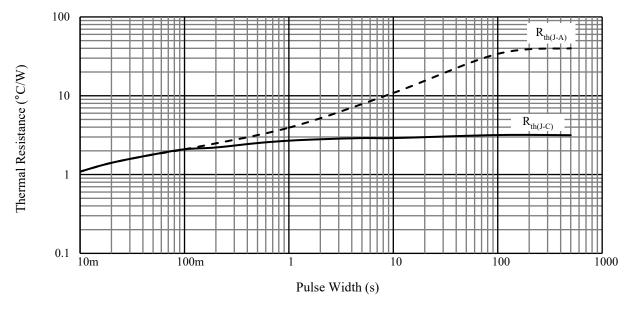
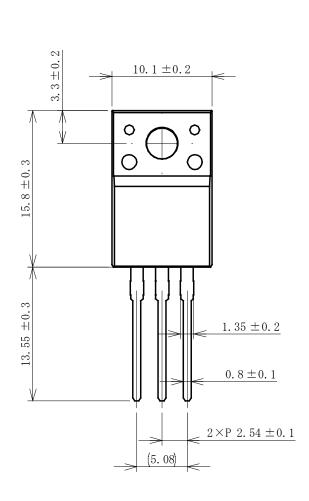
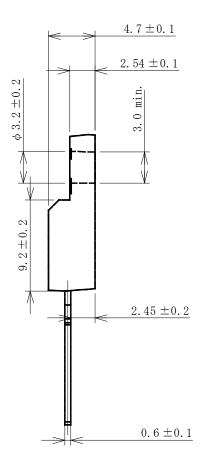


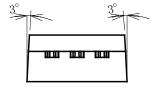
Figure 7. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

• TO220F-3L







NOTES:

- Dimensions in millimeters
- All the dimensions exclude mold flashes.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:

Flow: 270 °C / 7 s, 1 time

Soldering Iron: 350 °C / 3.5 s, 1 time

Soldering should be at a distance of at least 1.5 mm from the body of the product.

Marking Diagram

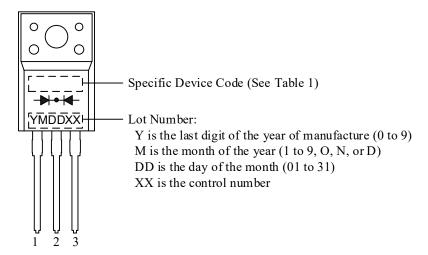


Table 1. Specific Device Code

Specific Device Code	Part Number
X12SL	FMX-12SL

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DSGN-CEZ-16003